



Pixelated Readout TPC Technology R&D for future Circular e^+e^- Collider

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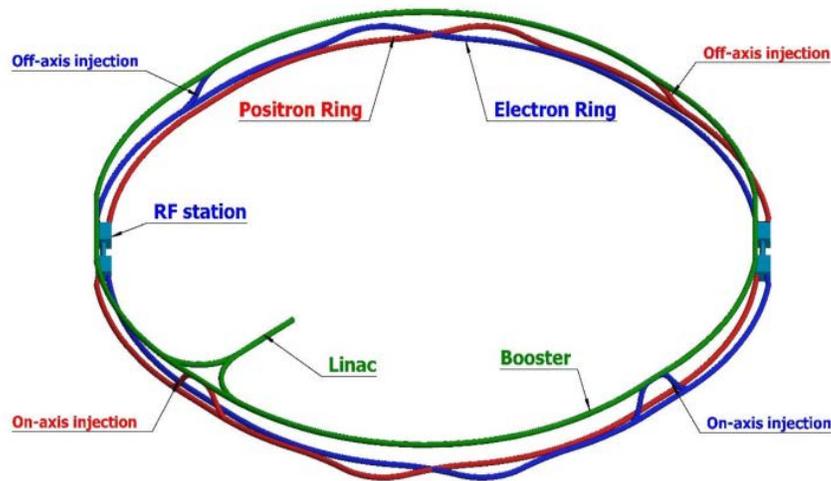
**On behalf of the CEPC gaseous tracker R&D group
and some inputs from LCTPC international collaboration**

IAS Program on Fundamental Physics, 14 January 2025, Hongkong

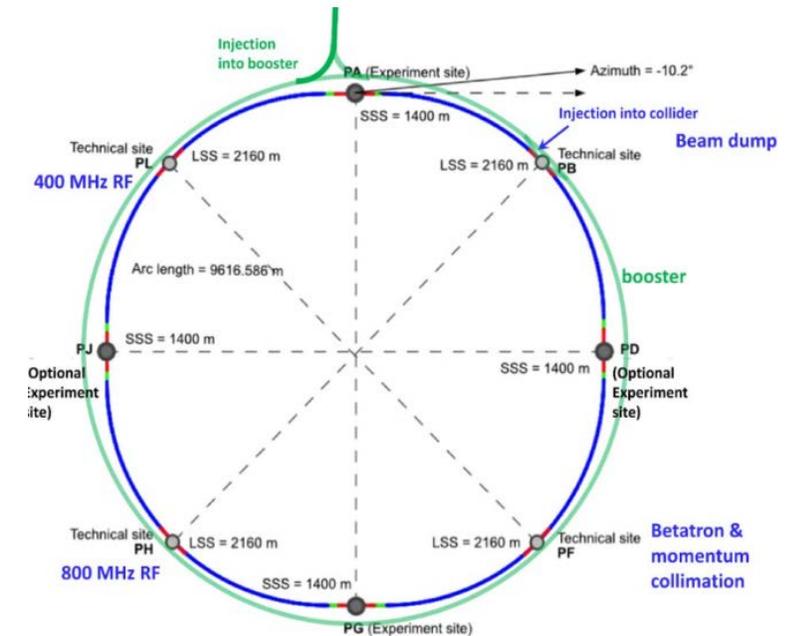
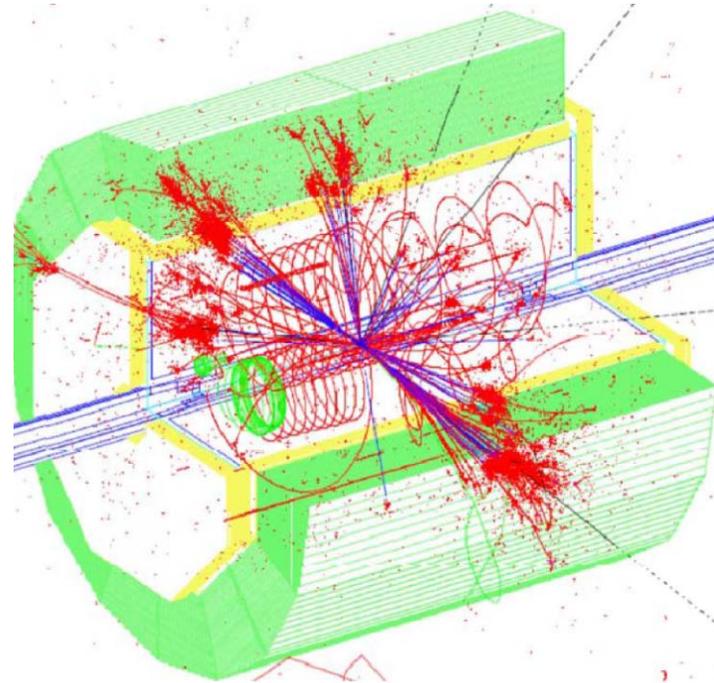
- **Motivation and physics requirements**
- **Status of TPC in CEPC and LCTPC**
- **Pixelated readout TPC for Higgs and Z**
- **Work plan and Summary**

Motivation and physics requirements

- A TPC is the main track detector for some candidate experiments at future e^+e^- colliders.
 - **Baseline detector concept** of ILD at ILC and CEPC
- TPC technology can be of interest for other future colliders (EIC, FCC-ee)
- Pixelated readout TPC can improve **PID requirements of Flavor Physics at e^+e^- collider.**



Circular Electron Positron Collider (CEPC)

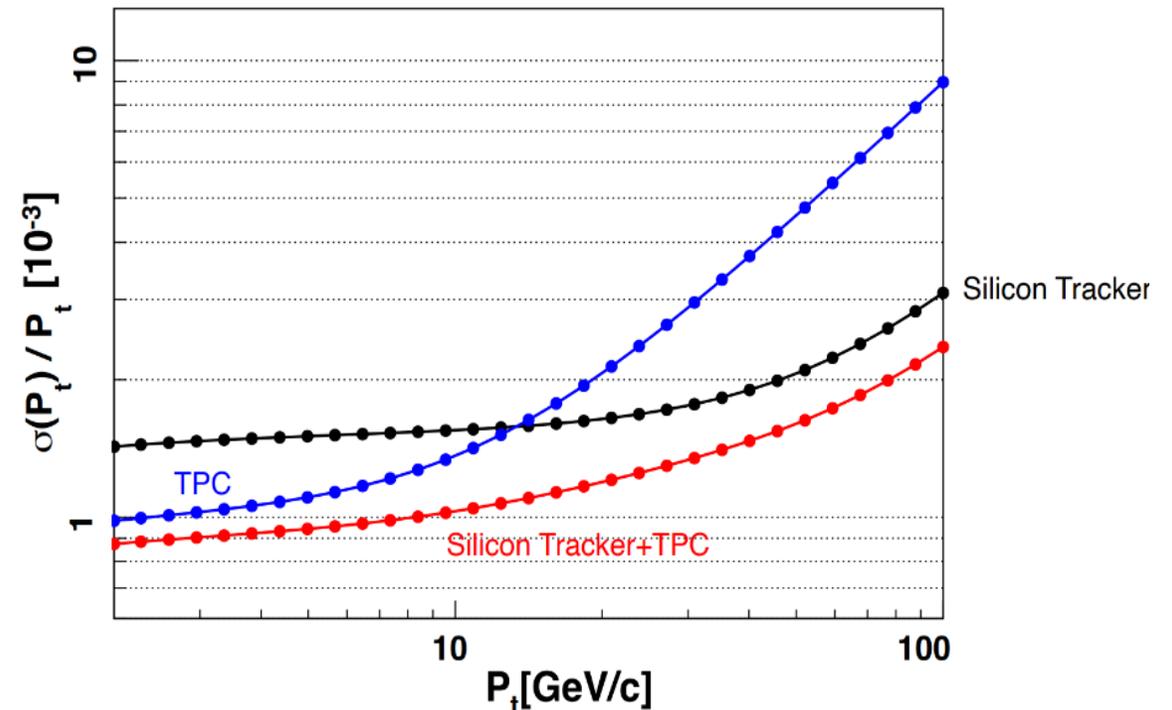
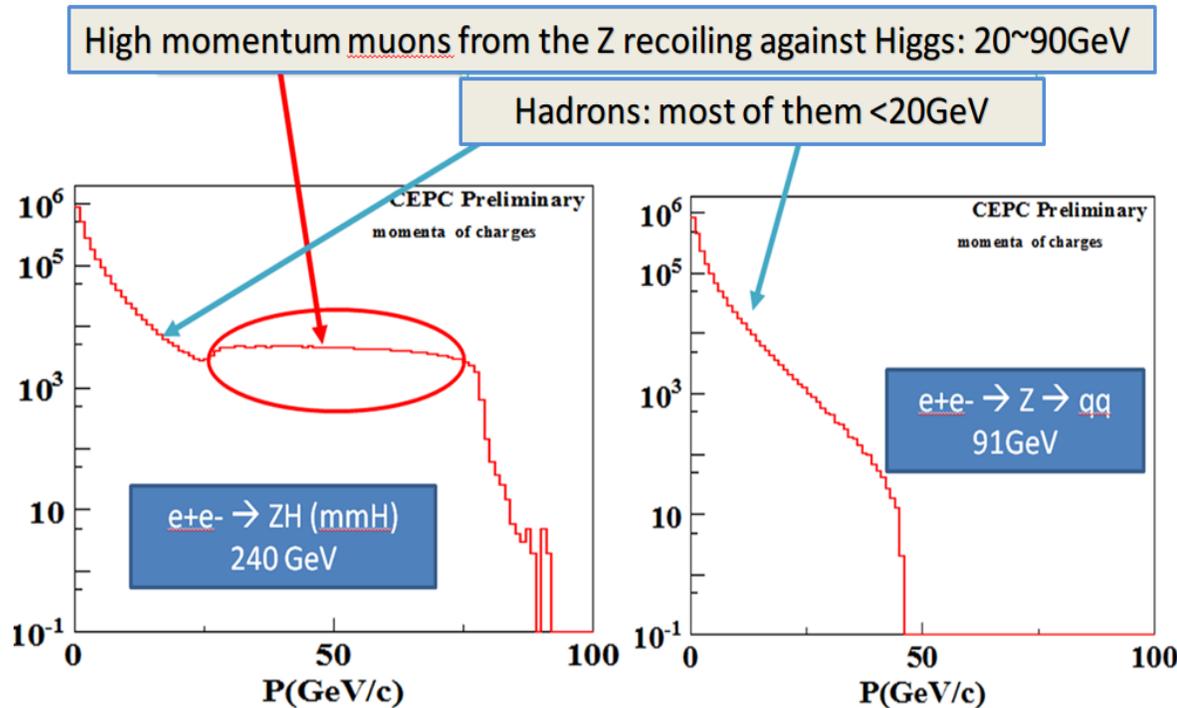


Future Circular Collider (FCCee)

Motivation and physics requirements

- Circular e+e- collider operation stages in TDR: **10-years Higgs @3T** → **2-years Z pole** → **1-year W**
- Physics Requirements of the tracker
 - High momentum resolution for Higgs and Z
 - PID for the flavor physics and jet substructure

Calibration: Low luminosity Z at 3T
 Approximately $10^{35} \text{cm}^{-2}\text{s}^{-1}$
 1%-20% of high luminosity Z

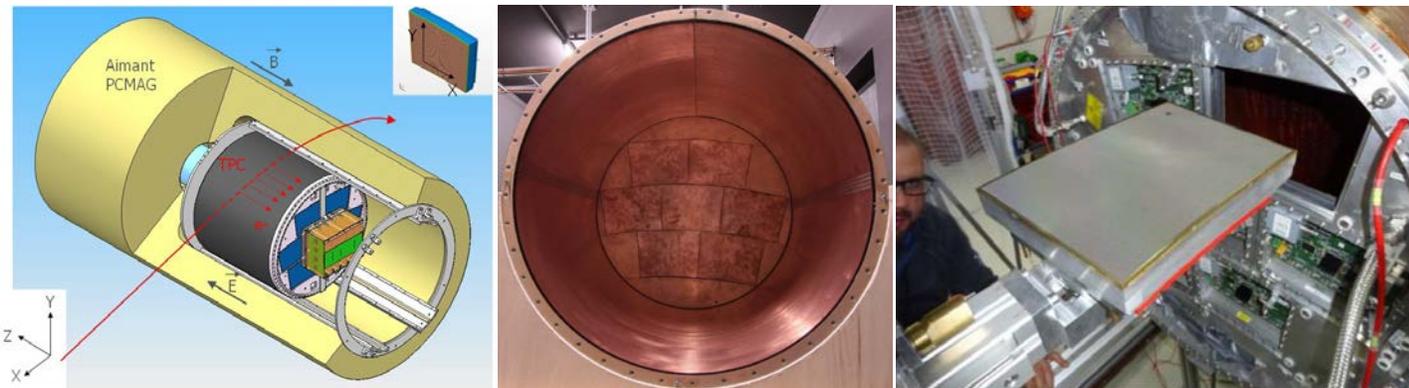


- **Status of TPC in CEPC and LCTPC**

Status of TPC in LCTPC

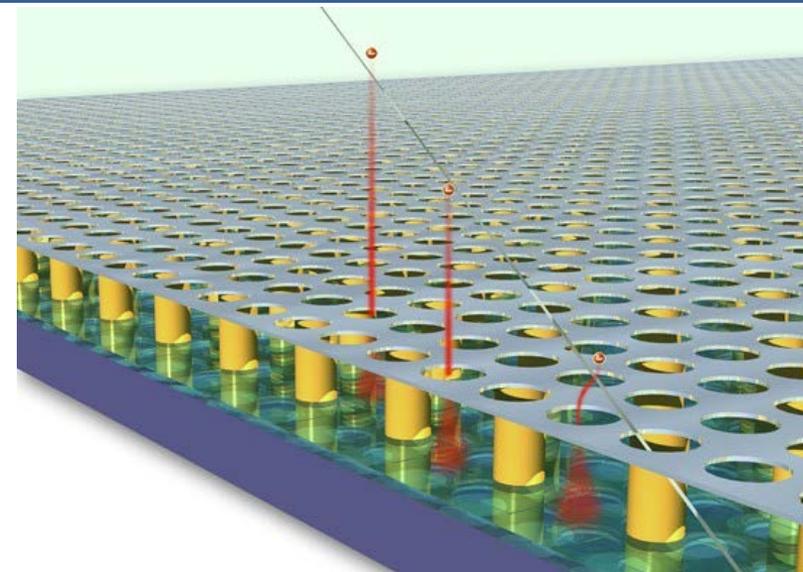
- **Large Prototype** setup has been built to compare different detector readouts under identical conditions and to address integration issues.
 - PCMAG: $B < 1.2\text{T}$, bore $\text{\O} = 85\text{cm}$
 - Two end plates for the LP made from Al with 7 module window
- **LP Field Cage Parameter**
 - Length = 61cm, inner $\text{\O} = 72\text{cm}$ drift field up to $E \approx 350\text{V/cm}$
 - Made of composite materials: 1.24 % X_0

JINST 5: P10011, 2010
JINST 16: P10023, 2021



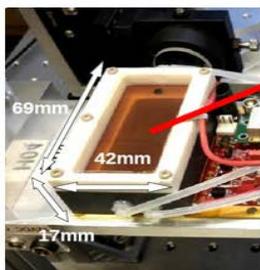
Status of TPC in LCTPC

- GridPix detector have moved from Timepix to Timepix3 ASICs. Tests with quad devices have been successfully done under $B=1.0T$ at DESY in 2021 and 2022.
- Very high detection efficiency results in **excellent tracking and dE/dx performance**. Timepix4 development is ongoing.
 - All results showed that **a pixel TPC is realistic.**($\sim 10^6$ events)

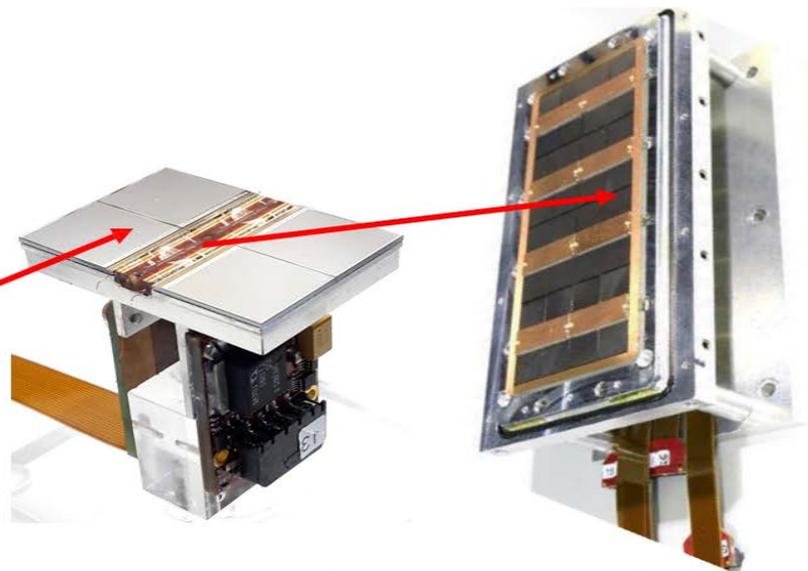


(Octopuce)

TimePix1
2007

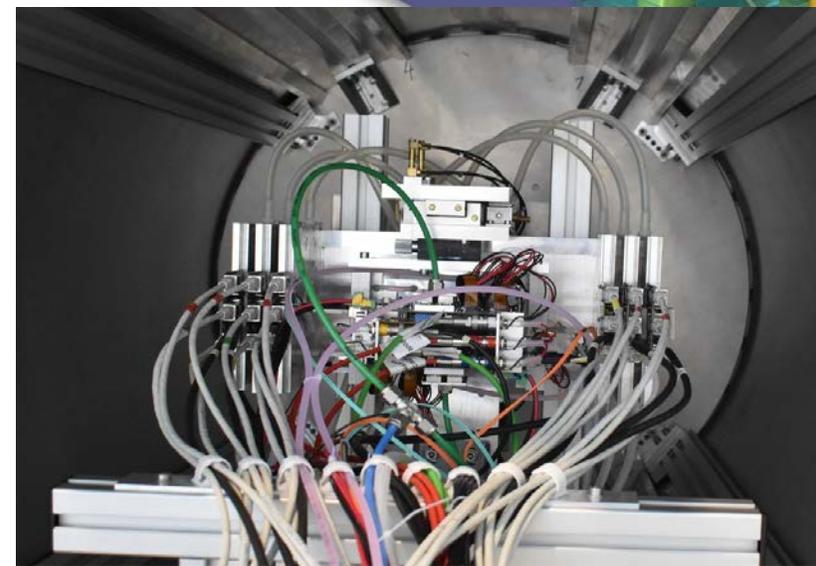


TPX3 chip
2017



Quad
2018

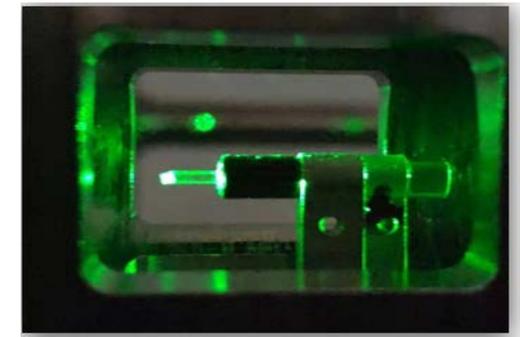
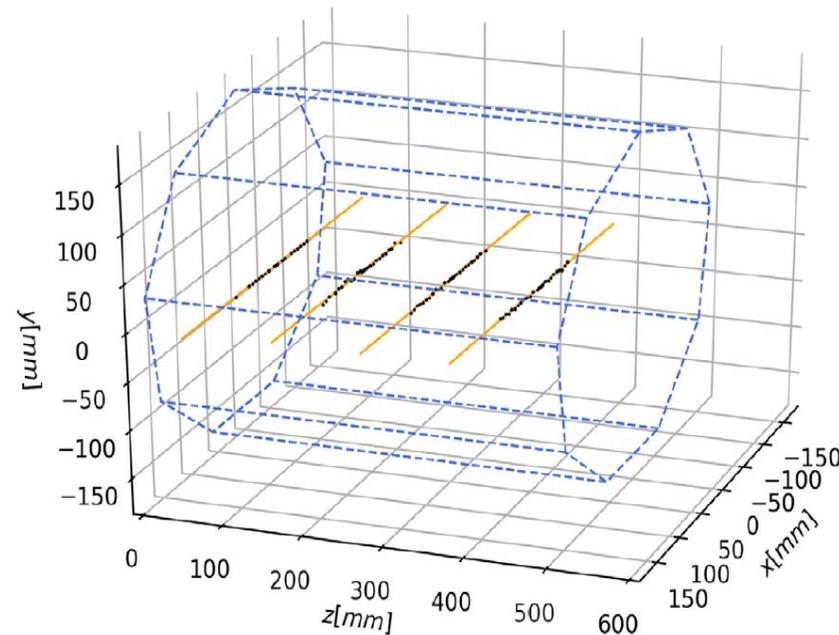
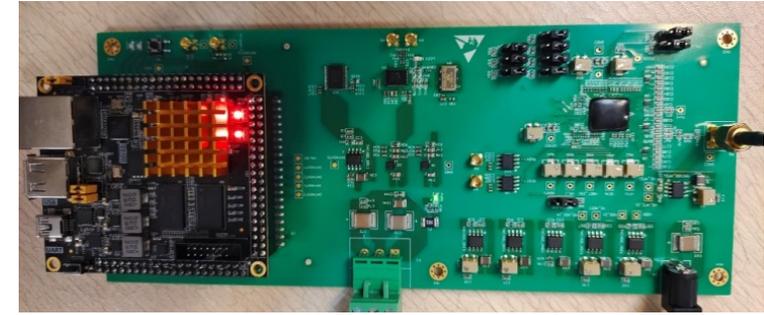
Module
2019



NIM A535 (2004) 506-510
NIM A845 (2017) 233-235

CEPCTPC prototype R&D efforts and results

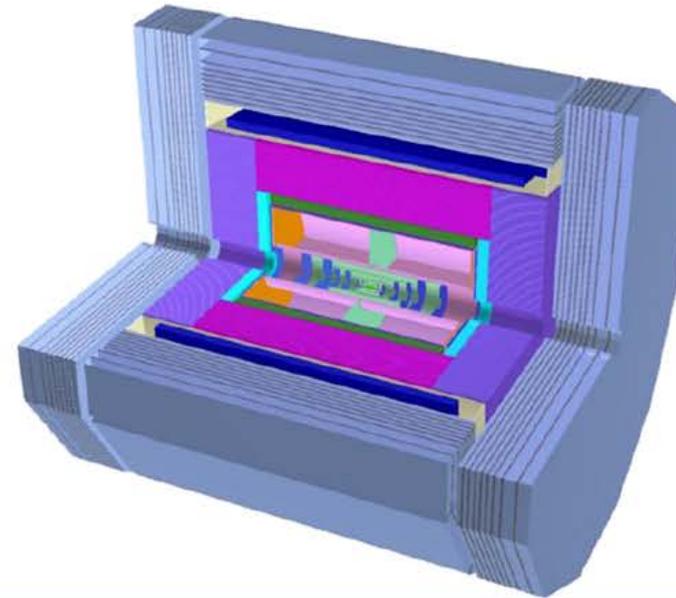
- **CEPC TPC detector prototyping roadmap:**
 - From TPC module to TPC prototype R&D for Higgs and Tera-Z
- **Achievement so far:**
 - **IBF \times Gain ~ 1 @ $G=2000$** validation with a hybrid TPC module
 - Spatial resolution of **$\sigma_{r\phi} \leq 100 \mu\text{m}$ and dE/dx resolution of 3.6%**
 - FEE chip: reach **$\sim 3.0\text{mW/ch}$ with ADC** and the pixelated readout R&D



Status of TPC in CEPC ref-TDR

- From January 2024, the CEPC community initiated the technical comparison and selection, balancing factors including **R&D efforts, detector performance, cost, power consumption and construction risks.**

System	Technologies	
	Baseline	For comparison
Beam pipe	Φ20 mm	
LumiCal	SiTrk+Crystal	
Vertex	CMOS+Stitching	CMOS Pixel
Tracker	CMOS SiDet ITrk	
	Pixelated TPC	PID Drift Chamber
	AC-LGAD OTrk	SSD / SPD OTrk
		LGAD ToF
ECAL	4D Crystal Bar	PS+SiPM+W, GS+SiPM, etc
HCAL	GS+SiPM+Fe	PS+SiPM+Fe, etc
Magnet	LTS	HTS
Muon	PS bar+SiPM	RPC
TDAQ	Conventional	Software Trigger
BE electr.	Common	Independent

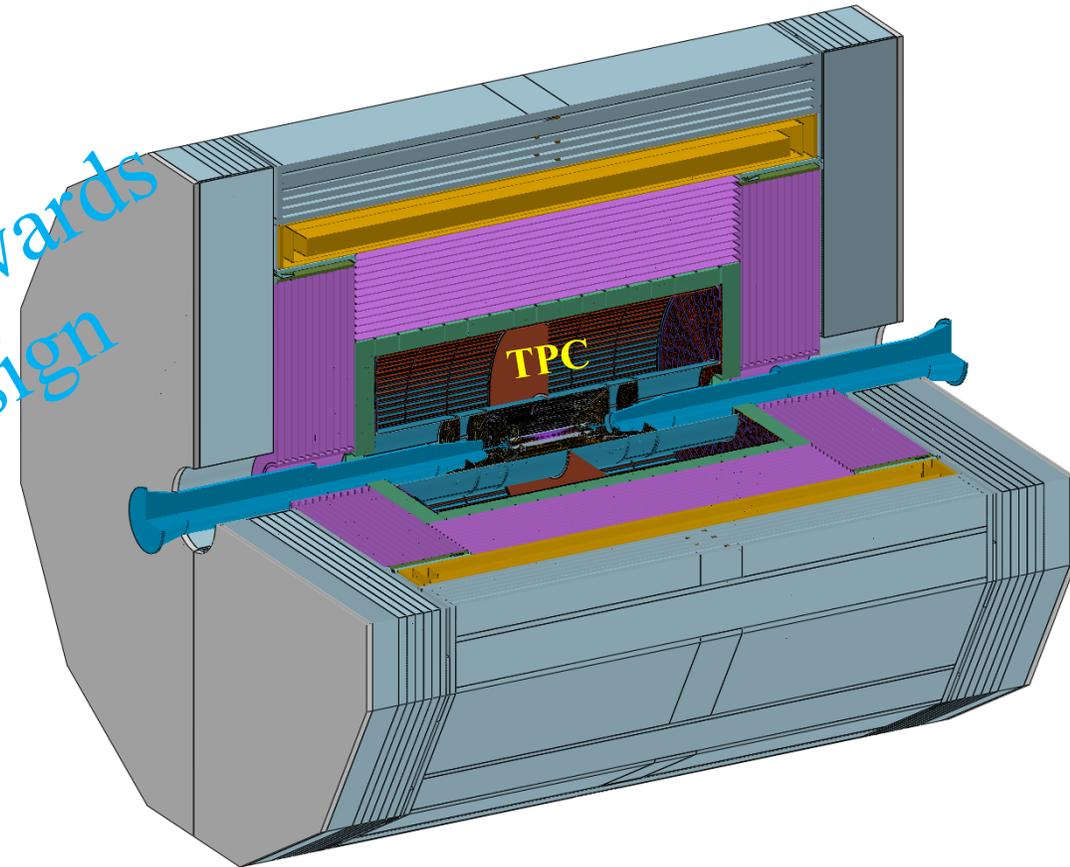
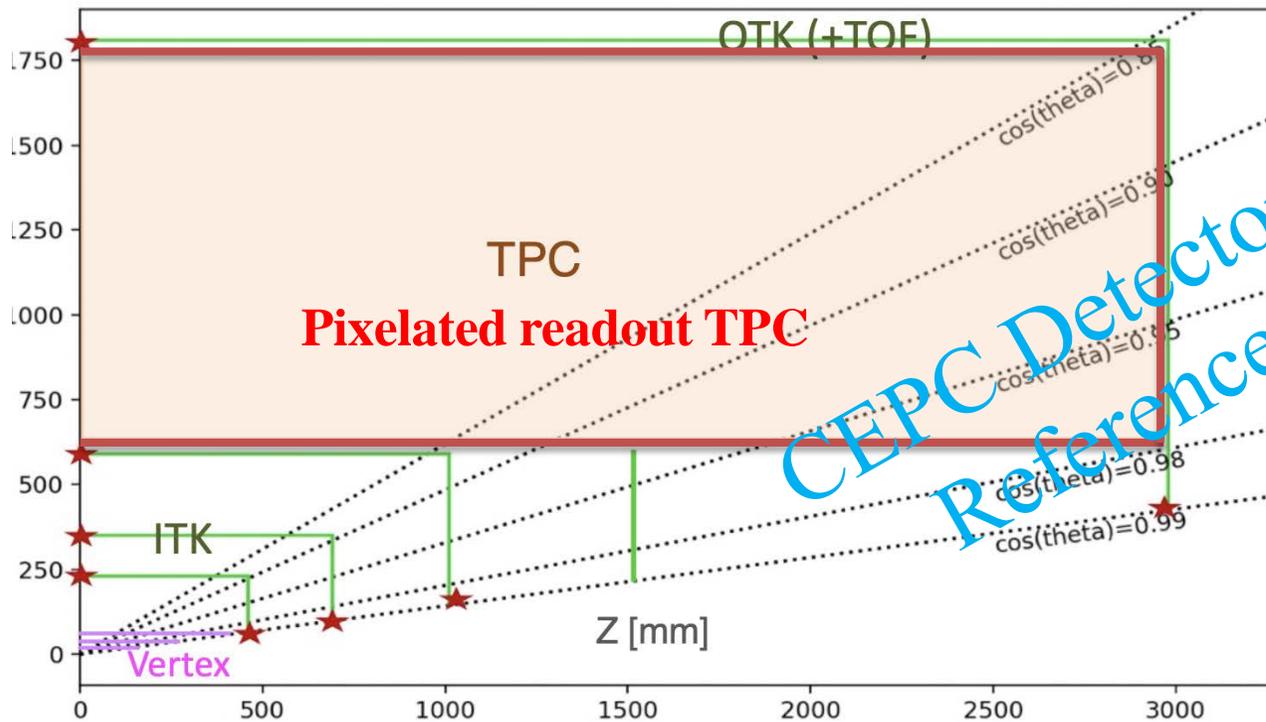


Foundations:

- CEPC Instrumentation R&D
- LHC detector upgrade projects
- other HEP experiments
- progress in HEP worldwide R&D
- development in industry

Baseline design of TPC technology in CEPC ref-TDR

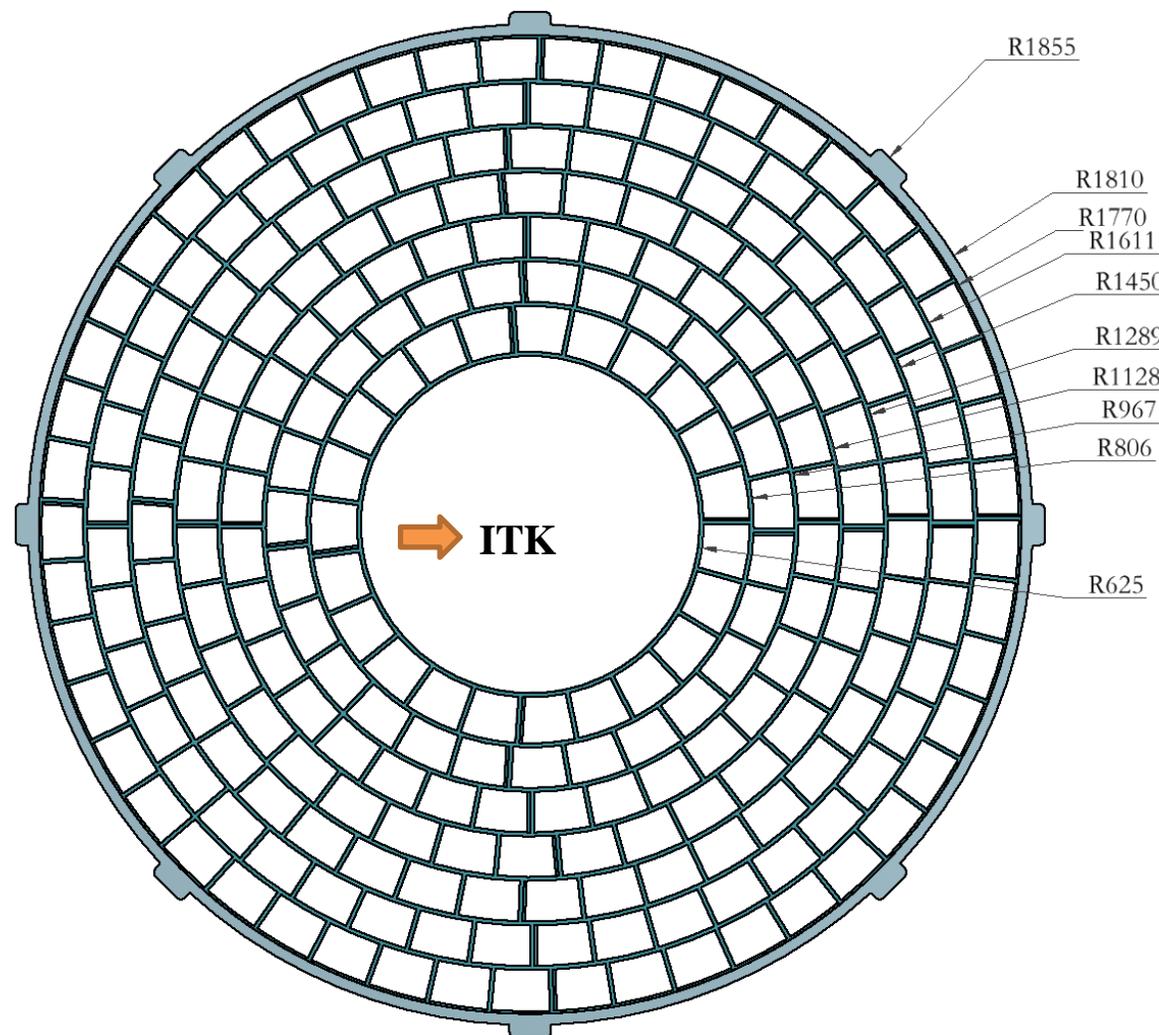
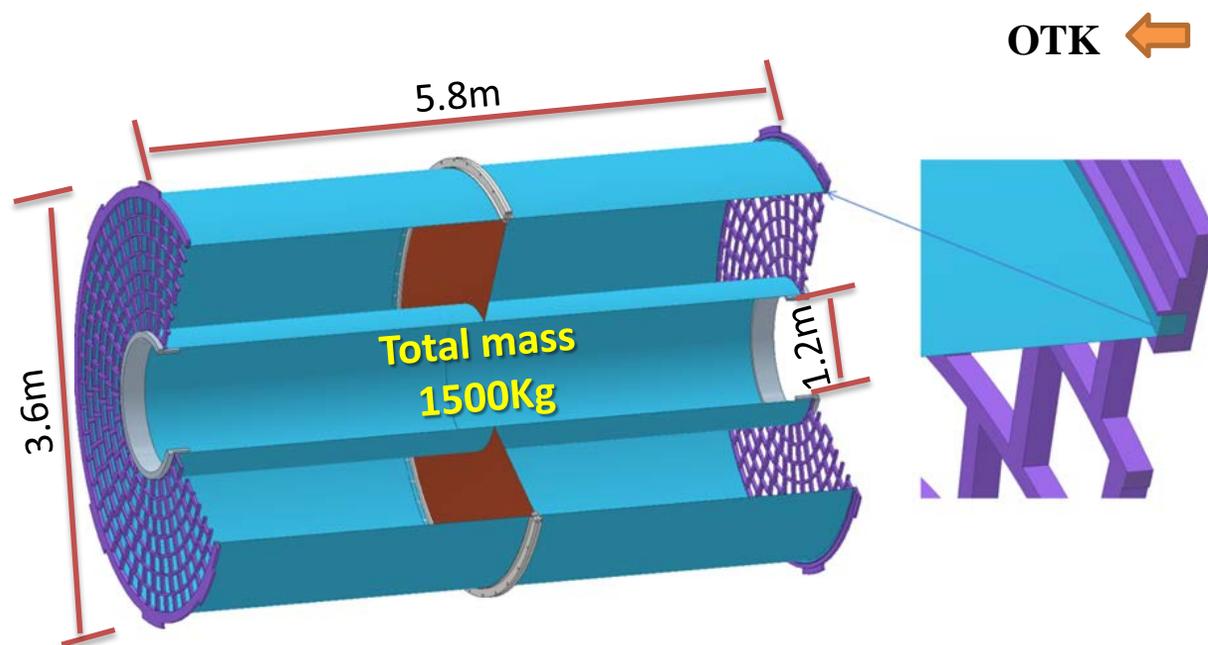
- Tracking system: Silicon combined with gaseous chamber for the tracking and PID
 - Pixelated readout TPC as the **baseline gaseous detector** in the CEPC ref-TDR
 - Radius of TPC from 0.6m to 1.8m



Geometry of the tracking detector system of the CEPC TDR

Parameters of TPC technology in CEPC ref-TDR

TPC detector	Key Parameters
Modules per endcap	248 modules /endcap
Module size	206mm × 224mm × 161mm
Geometry of layout	Inner: 1.2m Outer: 3.6m Length: 5.9m
Potential at cathode	- 62,000 V
Gas mixture	T2K: Ar/CF ₄ /iC ₄ H ₁₀ =95/3/2
Maximum drift time	34μs @ 2.75m
Detector modules	Pixelated Micromegas

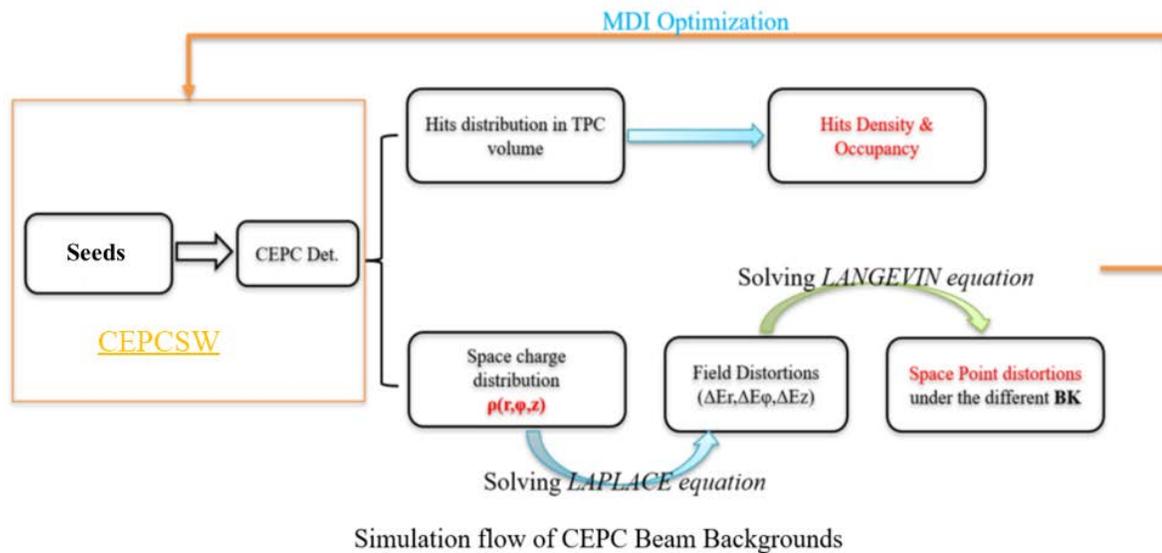


Detailed design of TPC detector in ref-TDR

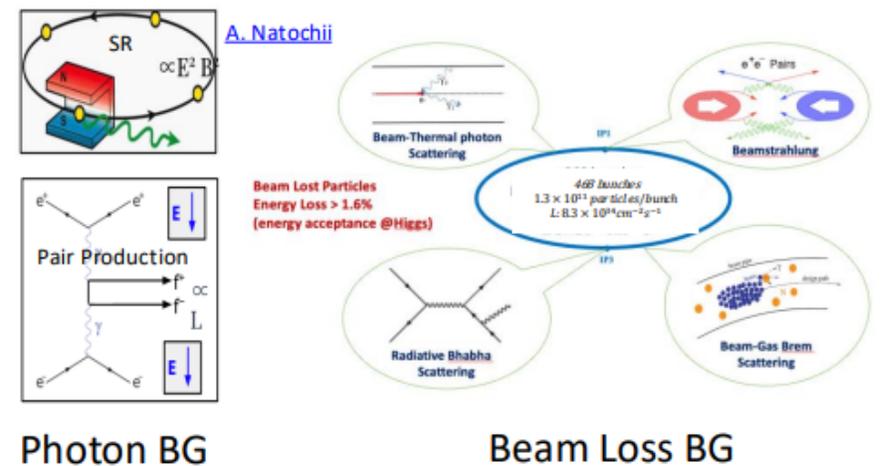
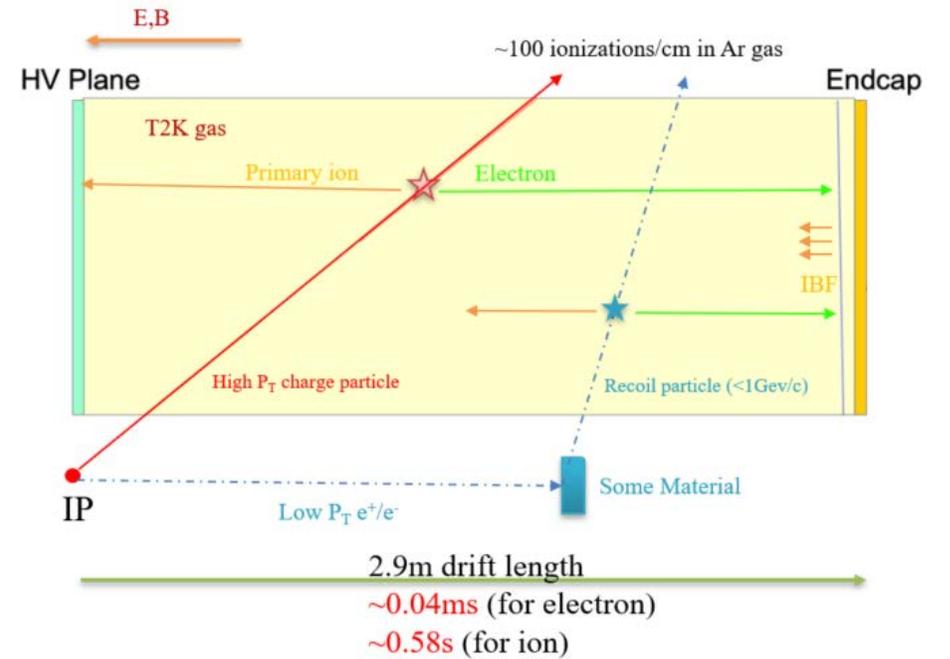
- **Pixelated readout TPC R&D for Higgs and Z**

Pixelated readout TPC for Higgs and Z

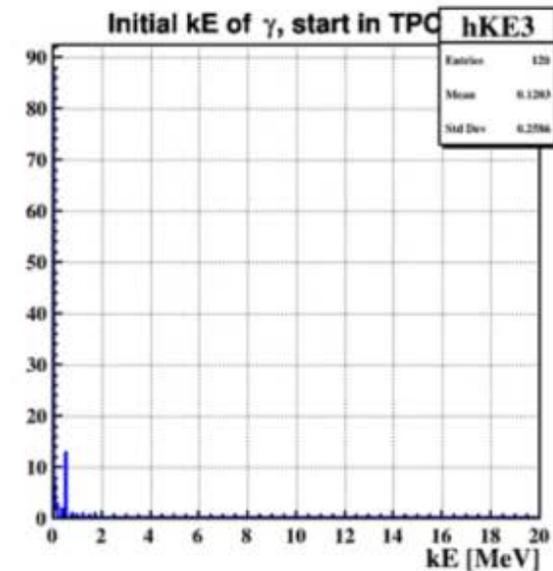
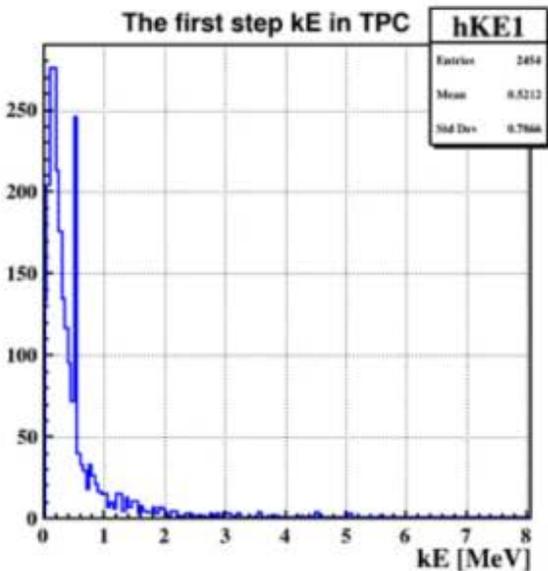
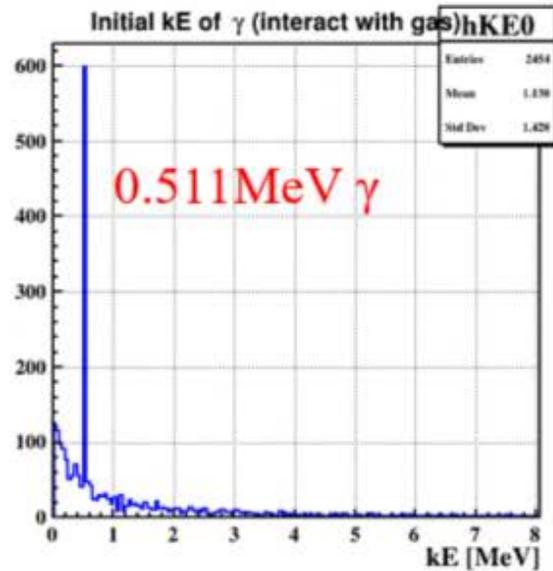
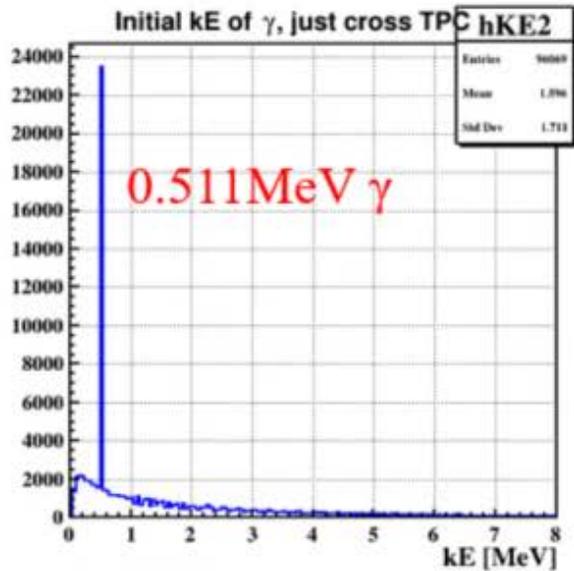
- Space charge in TPC chamber
 - Physics events: $H \rightarrow ss/cc/sb$, $Z \rightarrow qq \dots$ (High P_T)
- Higgs/Z background sources
 - I. Pair production (Luminosity related)
 - II. Single Beam (BGB, BGH, Touschek Scatter...)
 - III. Synchrotron Radiation
 - IV. Injection background
- Simulation framework



Simulation flow of CEPC Beam Backgrounds



Gamma (<10MeV) events at low luminosity Z @3T

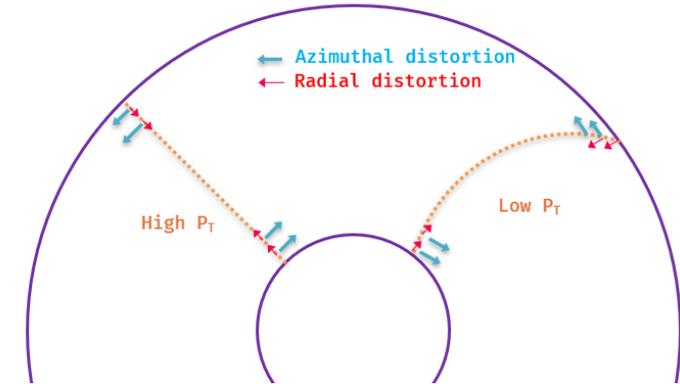


γ energy distribution (10BX WholeLZ241204 log)

- 1.2×10^7 tracks (γ, e^-, e^+, \dots) in total
- 8.4×10^6 γ tracks (~70.0%)
- 9.9×10^4 γ will cross TPC and ~ 2454 γ will interact with T2K gas through “compt, phot, conv” process, 96096 γ just cross TPC without energy deposit
- ~1.3% γ energy > 10 MeV
- Large number of 0.511 MeV γ (through e^+ annihilation)
- Average energy deposit: 27.12 MeV/BX by sum all secondary e^- dE , small less than the result from .root file (32.3 MeV/BX)
- So, low energy γ is the main contributions of beam background for TPC, similar to Higgs mode.

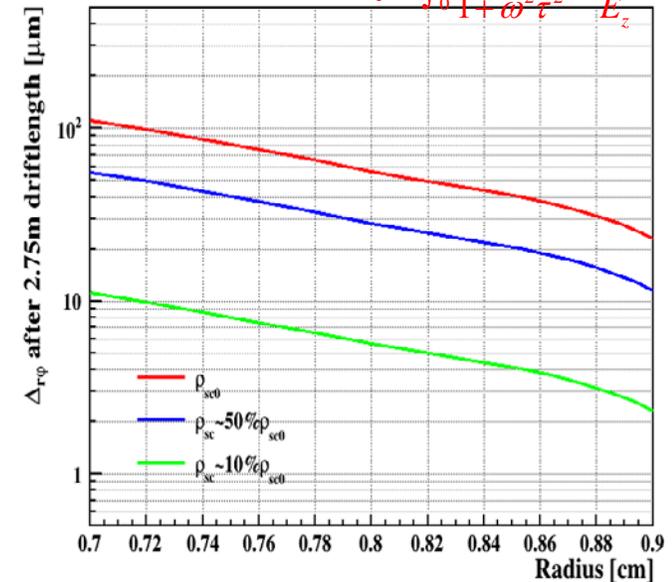
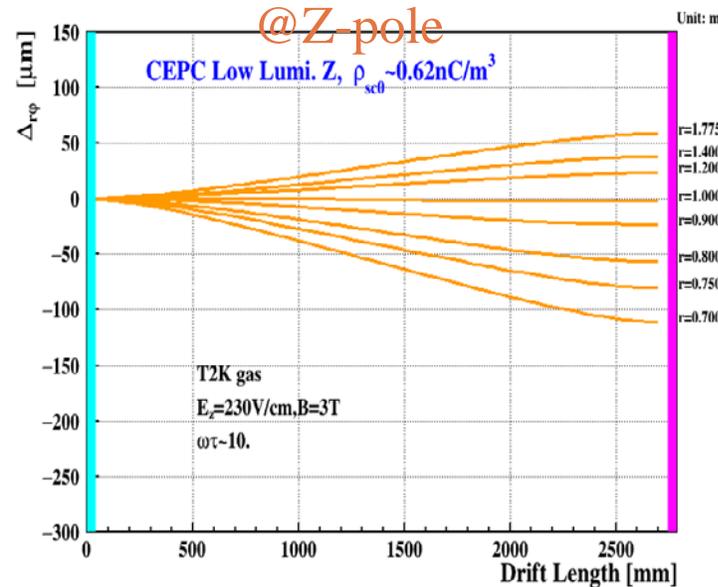
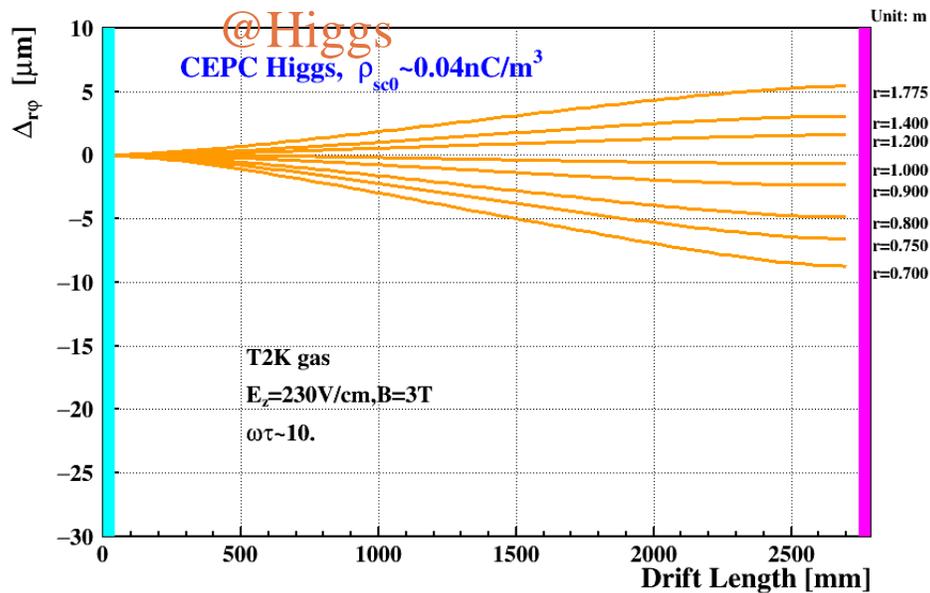
TPC distortion caused by primary ions

- Radial distortion (Δ_r) is much smaller than azimuthal distortion, almost imperceptible when along the track for most P_T track **IBF \times Gain=1, same primary ion level**
 - Azimuthal distortion ($\Delta_{r\phi}$) has much serious impact both on high/low P_T tracks
 - The maximum $\Delta_{r\phi}$ is $10\mu\text{m}$ @Higgs (**acceptable**)
 - The maximum $\Delta_{r\phi}$ can be reduced to $<100\mu\text{m}$ @Z-pole (**optimization of MDI**)
 - Including Pair + Single Beam



$$\Delta_{r\phi} = \int_0^L \frac{\omega\tau}{1 + \omega^2\tau^2} \times \frac{E_r}{E_z} dz$$

$$\Delta_r = \int_0^L \frac{1}{1 + \omega^2\tau^2} \times \frac{E_r}{E_z} dz$$

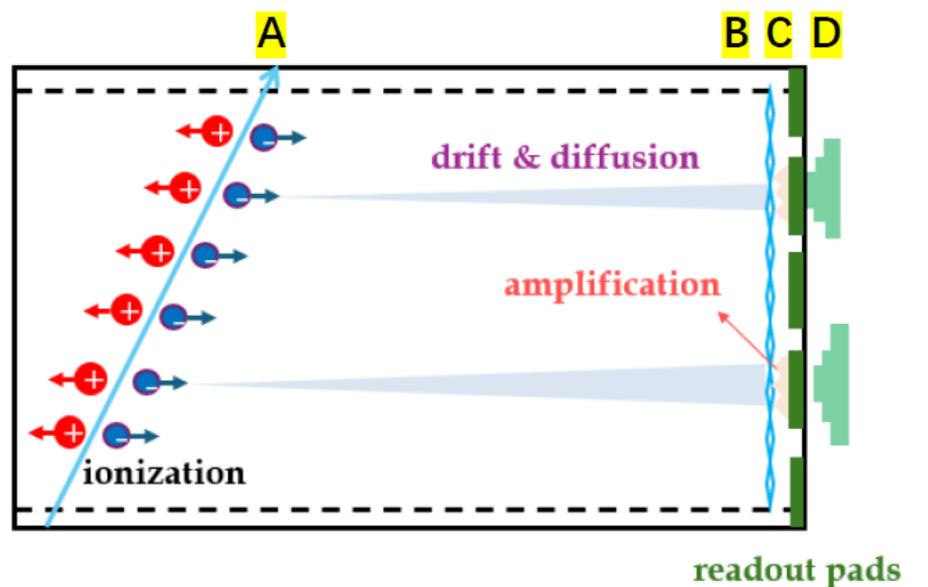


Numerical calculation results of TPC distortion

Full Simulation of Pixelated readout TPC

Simulation:

- With the full TPC geometry
- Ionization simulated with Garfield++
- Drift and diffusion from parameterized model based on Garfield++

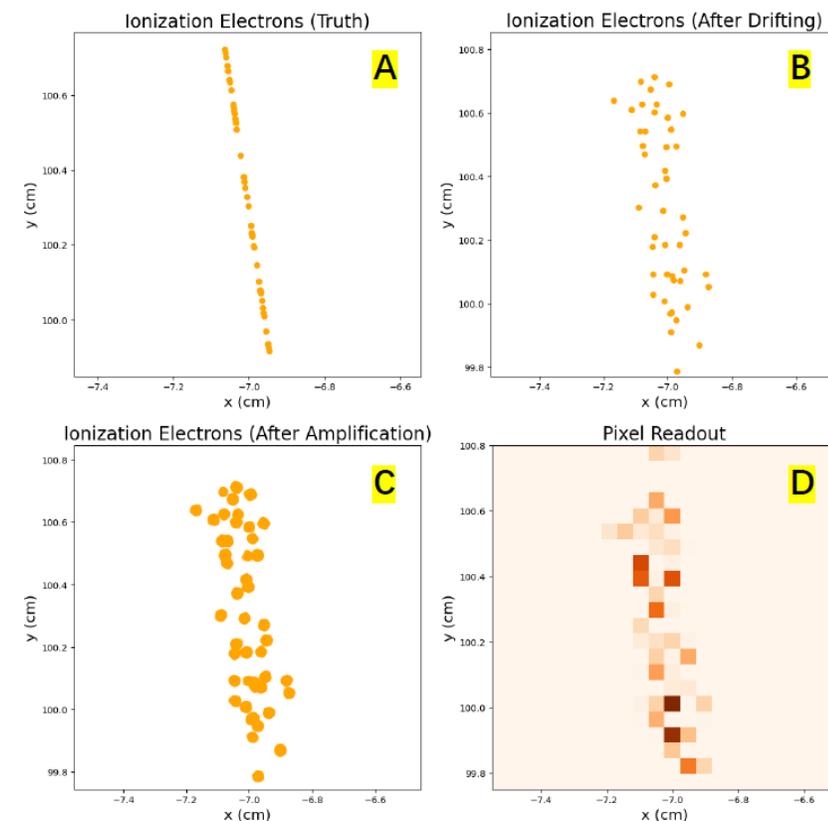


Garfield++-Based Simulation / Digitization Framework



Digitization (Refer to the TPC module and prototype):

- Electronic noise: 100 e⁻
- Amplification:
 - Number of electrons: 2000
 - Profile of signal size : 100 μ m



Simulation of TPC detector under 3T/2T and T2K mixture gas

Full Simulation of Pixelated readout TPC – Readout size

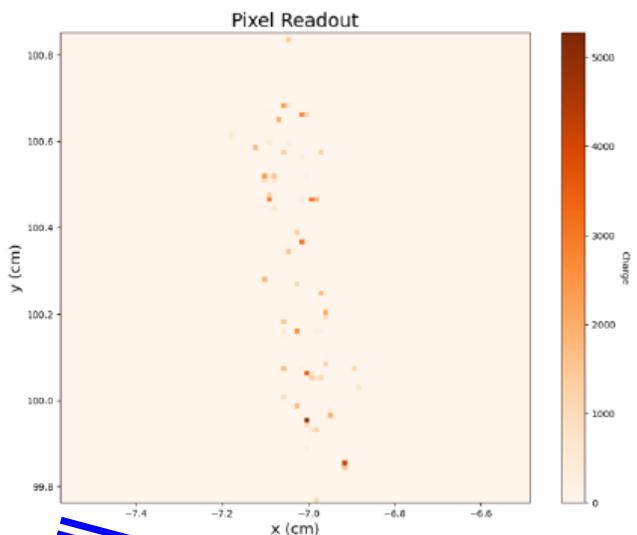
- Simulation of the readouts in pixel sizes
 - Actually, TPX3/4 option existing and the power consumption will be optimized.
 - Optimization started in this ref-TDR at IHEP to meet **Higgs/Z at 3T**.

■ Concerning pixel sizes for a TPC

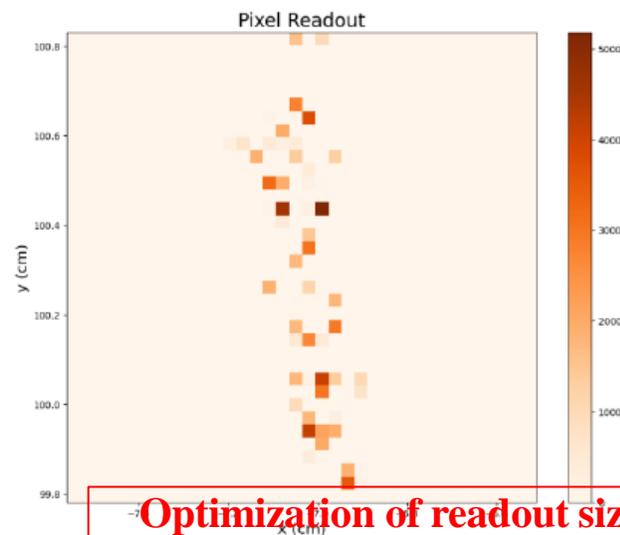
- A pixel size of 55 (110) microns is optimal; one can profit from cluster counting and high precision tracking
- Larger pixel/pad sizes have larger occupancies and one should question whether they can handle the very high beam-beam rate

Peter's comment
in CEPCWS at Hangzhou.

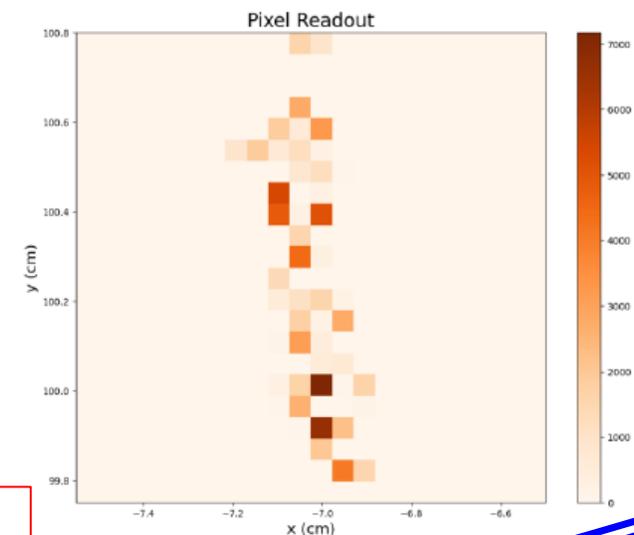
Pixel size = 110 um



Pixel size = 300 um



Pixel size = 500 um



Optimization of readout size
Balancing of performance, cost
power consumption, etc.

Full Simulation of Pixelated readout TPC - Reconstruction

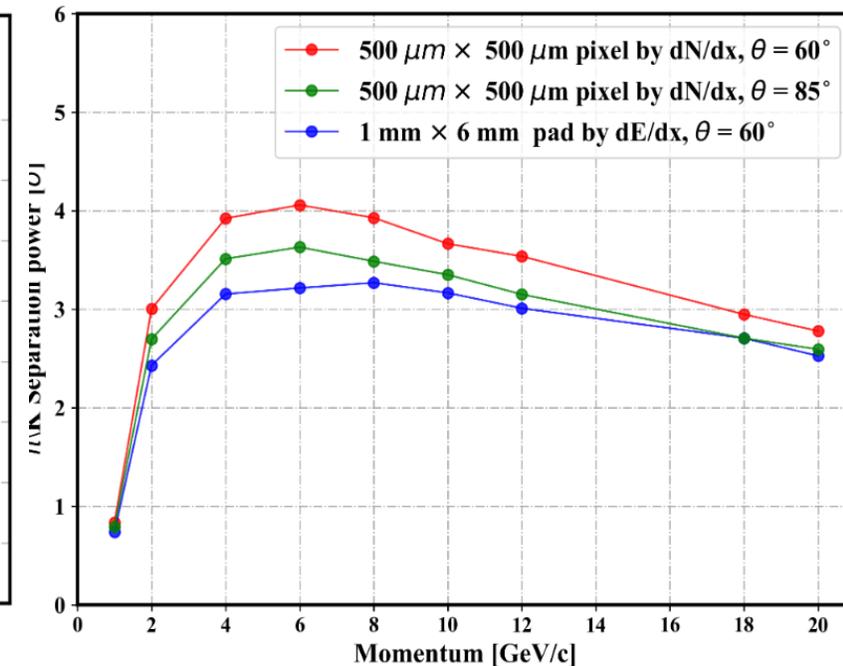
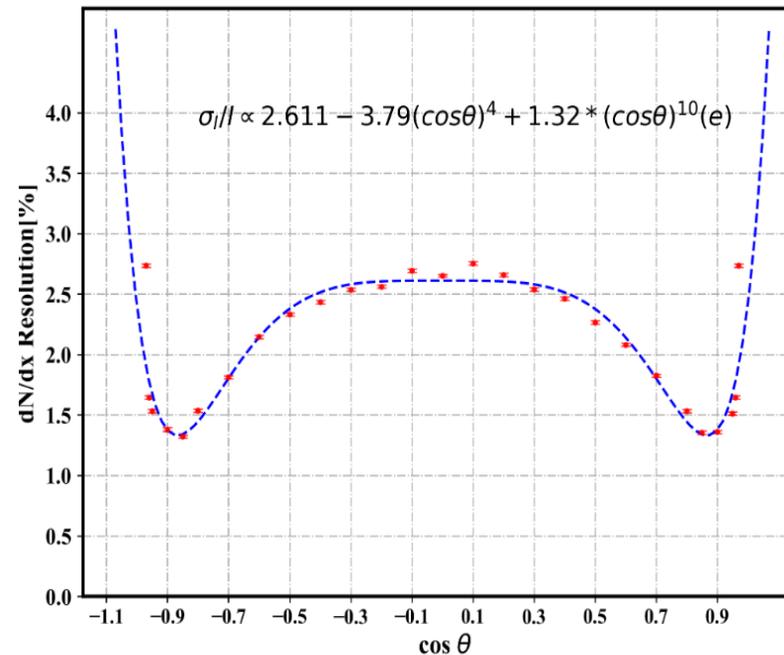
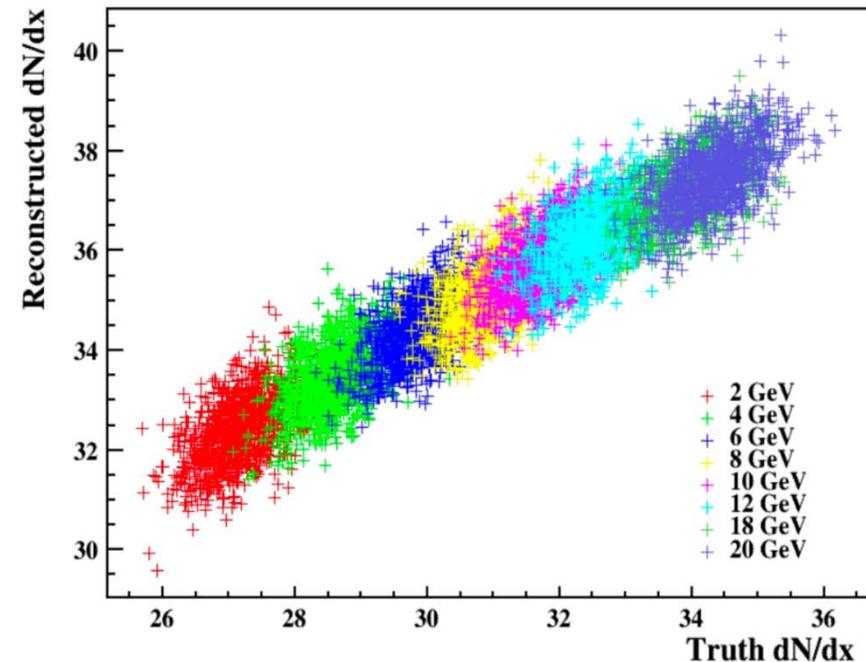
Reconstruction:

- Reconstruction by counting the number of fired pixels over threshold
- **Reconstruction with good linearity and reliability**

Preliminary PID performance:

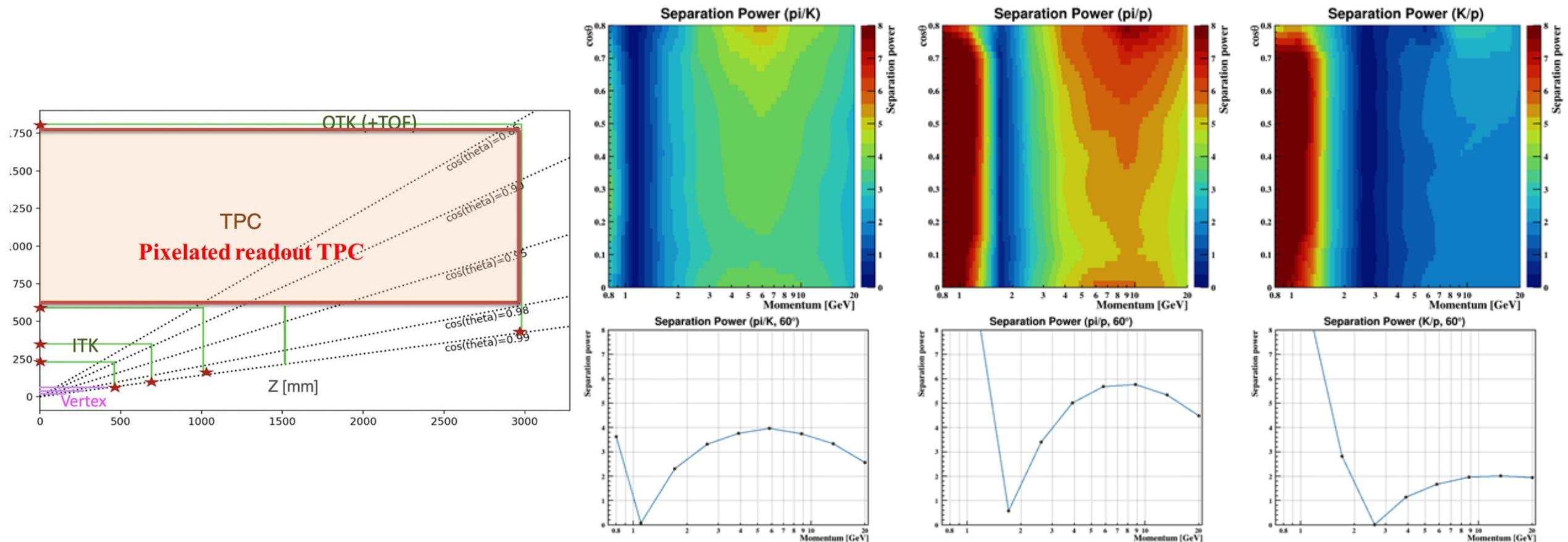
- π/k separation power simulation with different momentum

$$\text{Separation power: } \frac{|\mu_A - \mu_B|}{\frac{\sigma_A + \sigma_B}{2}}$$



Full Simulation of Pixelated readout TPC – PID performance

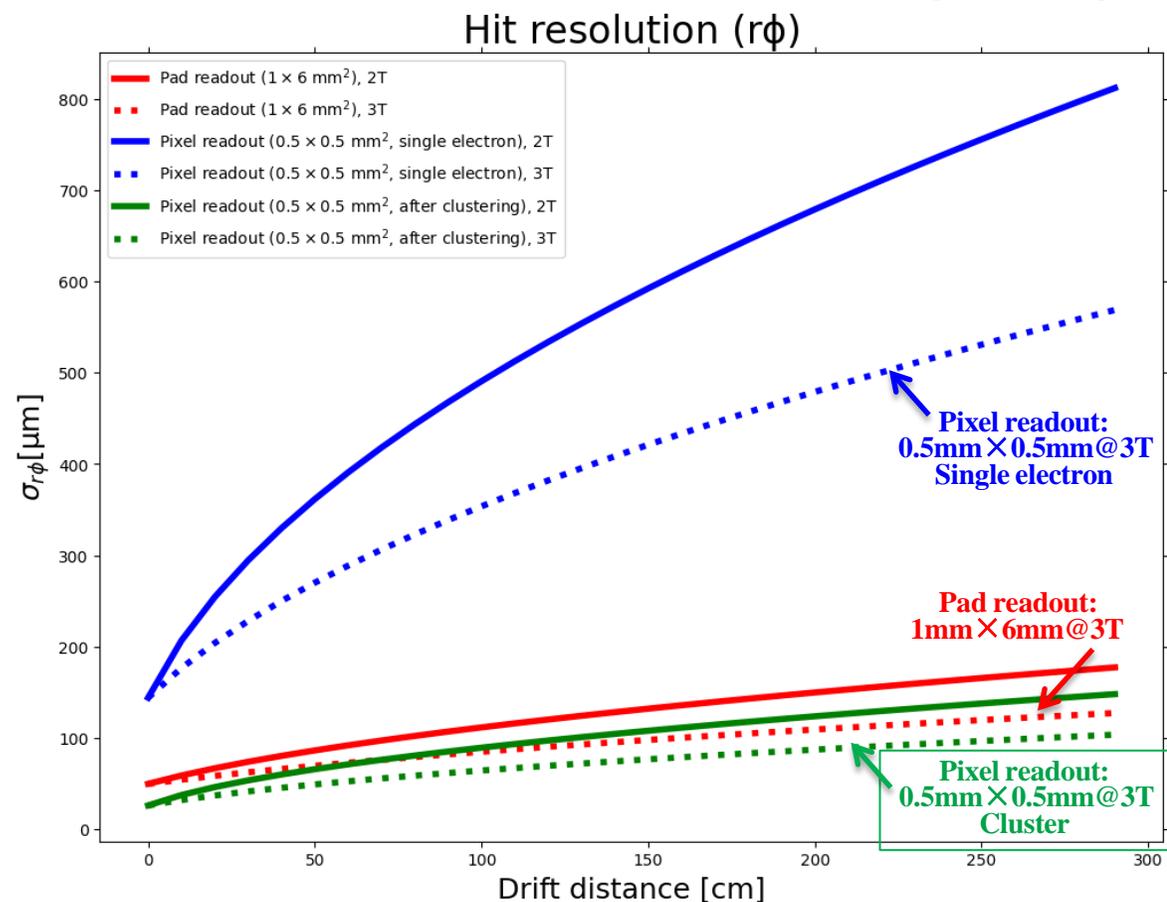
- Performance of the pixelated readout TPC
 - Simulation of π/K , π/p , and K/p separation power with varying momentum and $\cos\theta$



Full Simulation of Pixelated readout TPC – Spatial resolution

Estimation of the **spatial resolution using pixelated readout**.

- The granularity readout and the transverse diffusion are also taken into consideration..
- TPC can operate effectively at 3T B-field.
- Pixelated readout TPC can achieve superior spatial resolution at 3T compared to 2T.



Pad readout:

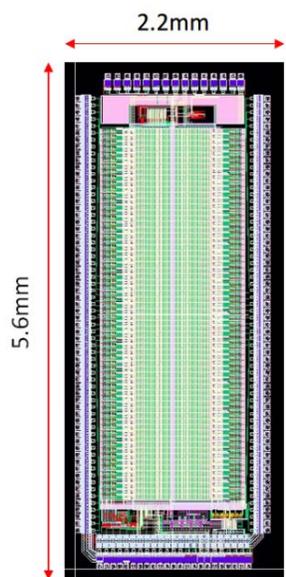
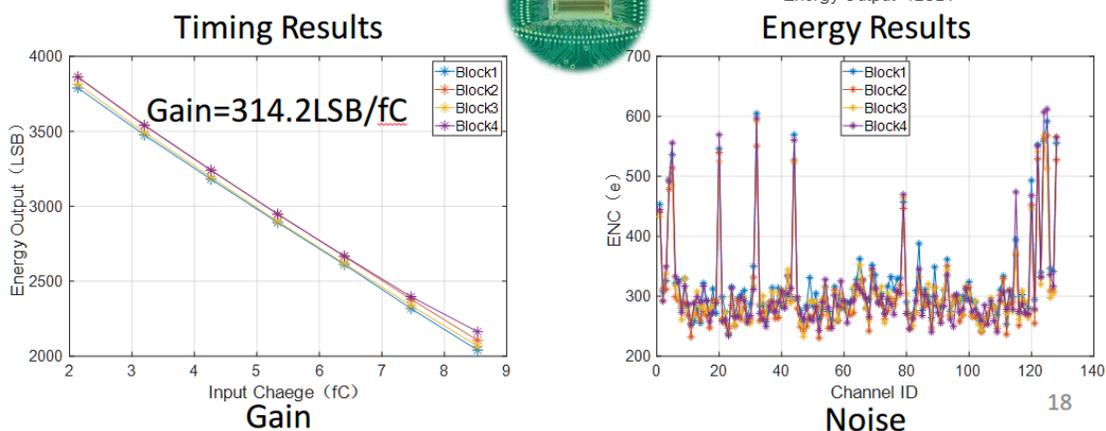
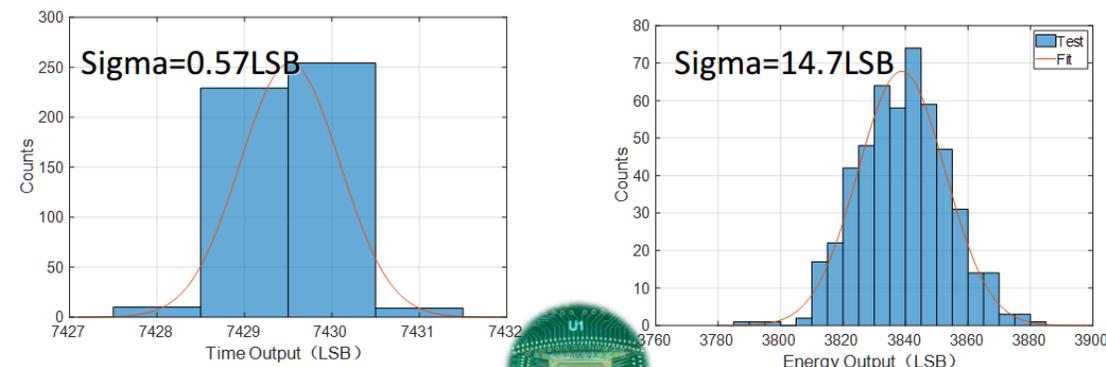
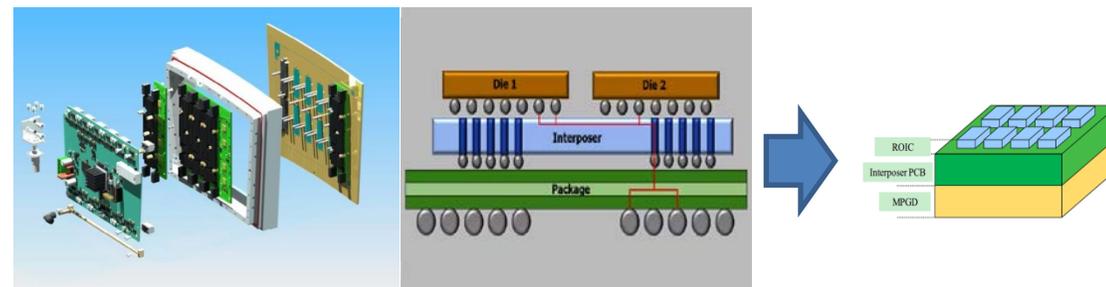
$$\sigma_{r\phi}^{\text{pad}} = \sqrt{(\sigma_{r\phi 0}^{\text{pad}})^2 + \sigma_{\phi 0}^2 \sin^2(\phi_{\text{track}}) + L \frac{D_{r\phi}^2}{N_{\text{eff}}} \sin(\theta_{\text{track}})}$$

Pixel readout:

$$\sigma_{r\phi}^{\text{pixel}} = \sqrt{(\sigma_{r\phi 0}^{\text{pixel}})^2 + LD_{r\phi}^2}$$

Full Simulation of Pixelated readout TPC – **TEPix with 500 μ m \times 500 μ m**

- Pixelated Readout Electronics: TEPix development
 - Multi-ROIC chips + Interposer PCB as RDL
 - Four-side bootable
- TEPix: Low power Energy/Timing measurement
 - Low power consumption: 0.5mW/ch@2nd Chip
 - Timing: 1 LSB(<10ns)
 - Noise: 300e- (high gain)

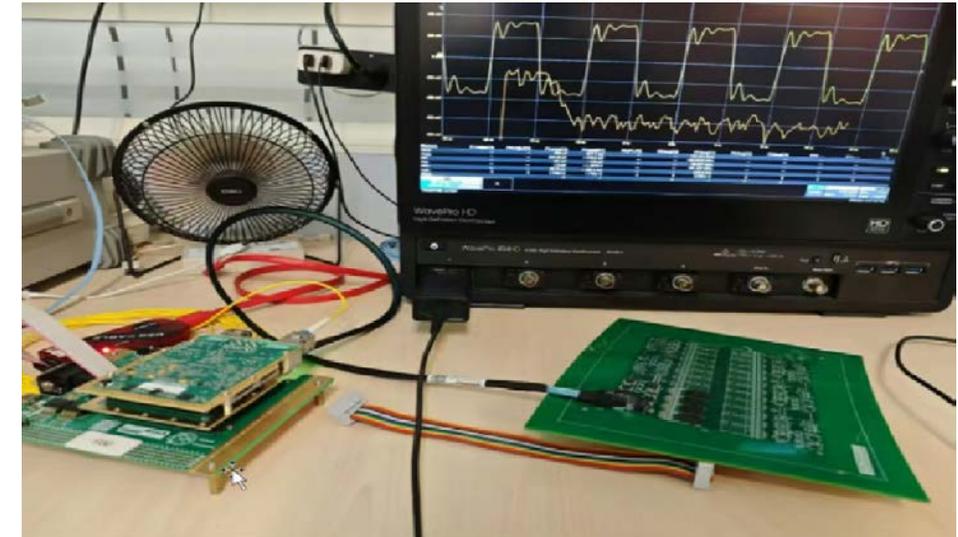
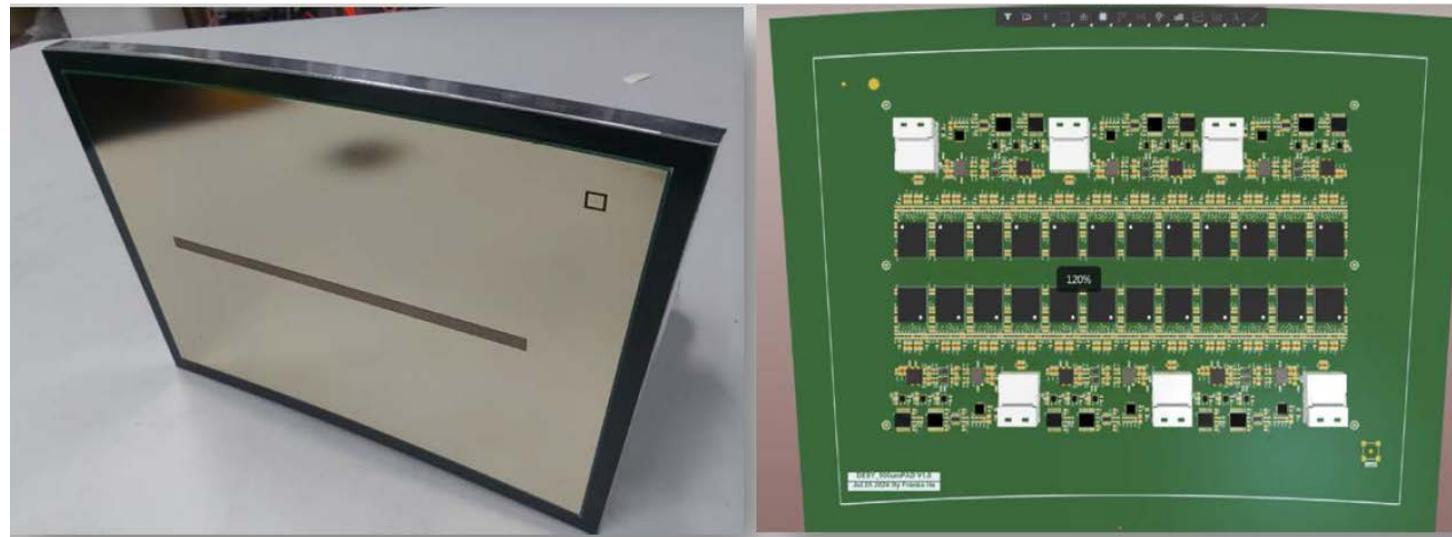
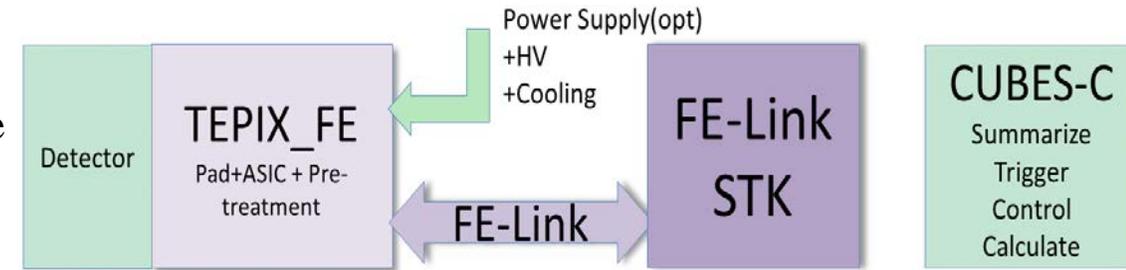


Parameter	Spec
Number of channels	128
Power Consumption	Analog<30mW
	Digital<30mW
ENC	~300 e(high gain)
Dynamic Range	25fC(high gain)
	150fC(low gain)
INL	<1%
Time Resolution	<10ns

FEE ASIC: TEPix—Test Results in May

Validation and commissioning of TPC prototype

- **R&D on Pixelated TPC readout for CEPC TDR.**
 - ASIC chip developed and **2nd prototype wafer has been done** and tested.
 - The TOA and TOT can be selected as the initiation function in the ASIC chip
- **Beam test of the pixelated readout TPC prototype in preparation. (April –May , 2025)**

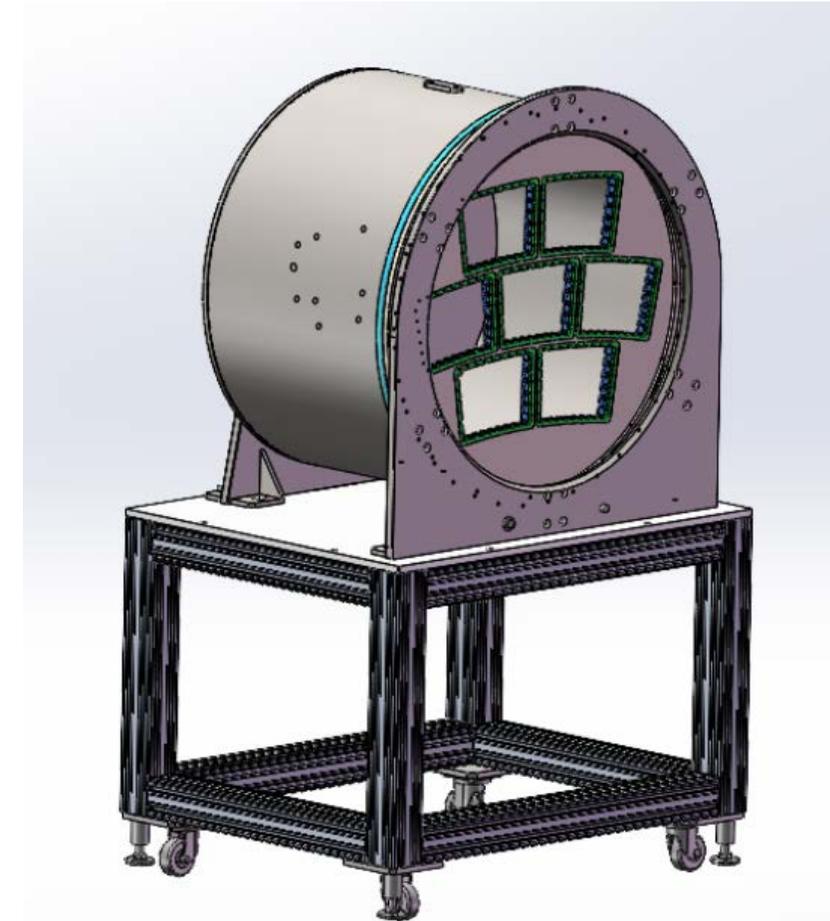


Photos TPC modules assembled for the beam test

Work plan

- **Short term work plan (before June, 2025)**
 - Optimization of TPC detector for CEPC ref-TDR
 - Prototyping R&D and validation with the test beam
 - mechanics, manufacturing, beam test, full drift length prototype
 - Performance of the simulation and Machine Learning algorithm
- **Long term work plan (next 3-5 years)**
 - Development of TPC prototype with low power consumption FEE
 - Collaboration with LCTPC collaboration on beam test
 - Development of the full drift length prototype
 - Drift velocity. Attachment coefficient, T/L Diffusion, etc.

Milestones achieved	Before June, 2025	Beyond TDR
Ion backflow suppression	IBF × Gain < 1 (Gain=2000)	Graphene technology
Pixelated readout prototype	Validation with beam test	Prototype with Multi-modules
Power consumption ASIC	~100mW/cm² (60nm ASIC)	Optimization 330μm - 500μm
PID resolution	3% (dN/dx)	<3% (dN/dx)
Material budget (barrel)	Carbon Fiber	Full size prototype



- In LCTPC collaboration, TPC detection technology R&D using the pad readout towards the pixelated readout for Higgs and Z run at the future e+e- collider.
- Pixelated TPC is chosen as the baseline gaseous tracker in CEPC ref-TDR. The simulation results show that both of PID performance and the momentum resolution are good. Validation with TPC prototype in preparation before TDR.
- Synergies with CEPC/DRD1/FCCee/EIC/LCTPC allow us to continue R&D and ongoing with the significant international collaboration. All of contributions will input to CEPC ref-TDR in next few months.

Many thanks!